

1. General description

High voltage, high speed planar passivated NPN power switching transistor in a SOT78 (TO-220AB) plastic package.

2. Features and benefits

- Fast switching
- Low thermal resistance
- Very high voltage capability
- Very low switching and conduction losses

3. Applications

- DC-to-DC converters
- High frequency electronic lighting ballasts
- Inverters
- Motor control systems

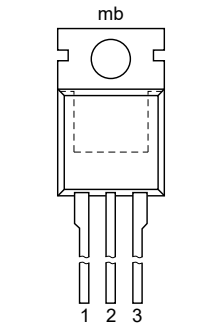
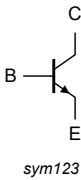
4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------|--------------------------------|---|-----|-----|------|------|
| I_{CM} | peak collector current | Fig. 1 ; Fig. 2 ; Fig. 3 | - | - | 10 | A |
| P_{tot} | total power dissipation | $T_{mb} \leq 25\text{ °C}$; Fig. 4 | - | - | 100 | W |
| V_{CESM} | collector-emitter peak voltage | $V_{BE} = 0\text{ V}$ | - | - | 1000 | V |
| Static characteristics | | | | | | |
| h_{FE} | DC current gain | $I_C = 5\text{ mA}$; $V_{CE} = 5\text{ V}$; $T_{mb} = 25\text{ °C}$; Fig. 11 | 10 | 22 | 35 | |
| | | $I_C = 500\text{ mA}$; $V_{CE} = 5\text{ V}$; $T_{mb} = 25\text{ °C}$; Fig. 11 | 14 | 25 | 35 | |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|---------------------------------------|---|---|
| 1 | B | base |  <p>TO-220AB (SOT78)</p> |  |
| 2 | C | collector | | |
| 3 | E | emitter | | |
| mb | C | mounting base; connected to collector | | |

6. Ordering information

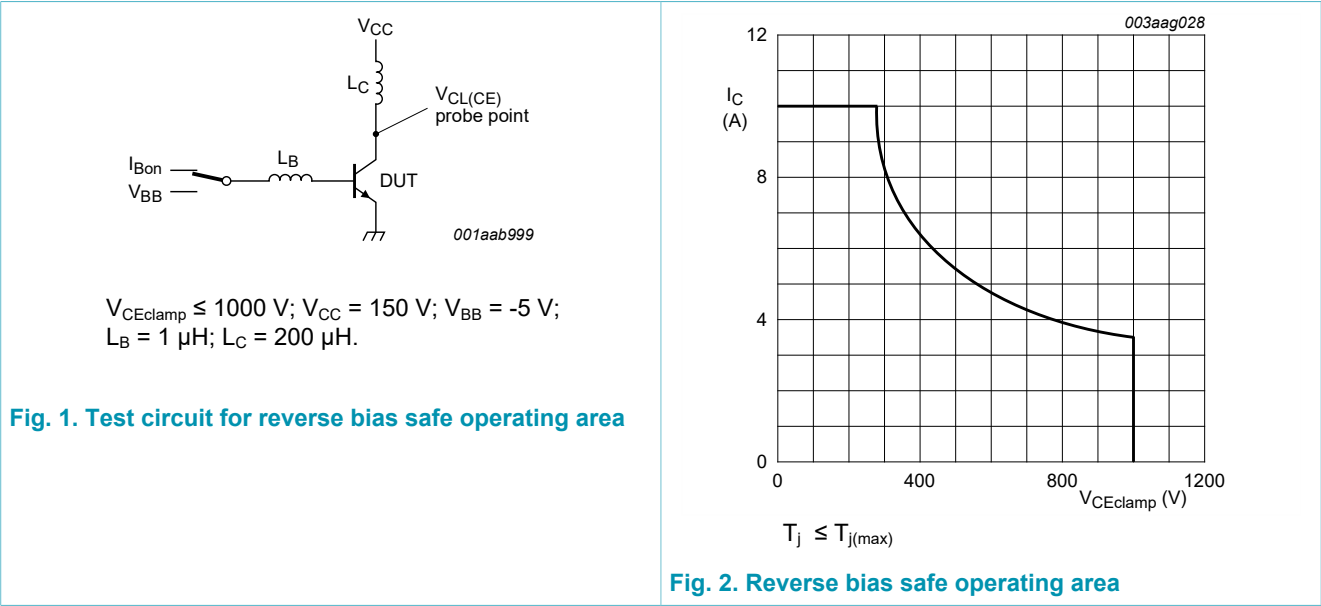
Table 3. Ordering information

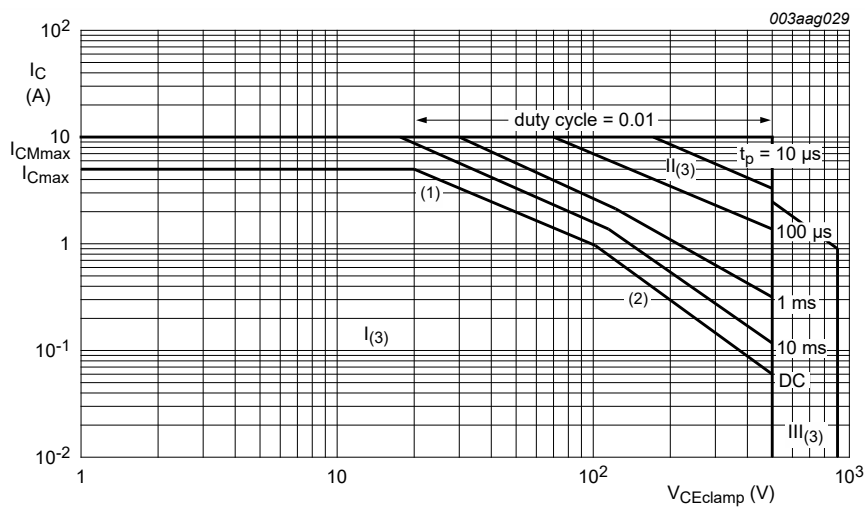
| Type number | Package | | |
|-------------|----------|--|---------|
| | Name | Description | Version |
| BUJ303A | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 |

7. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

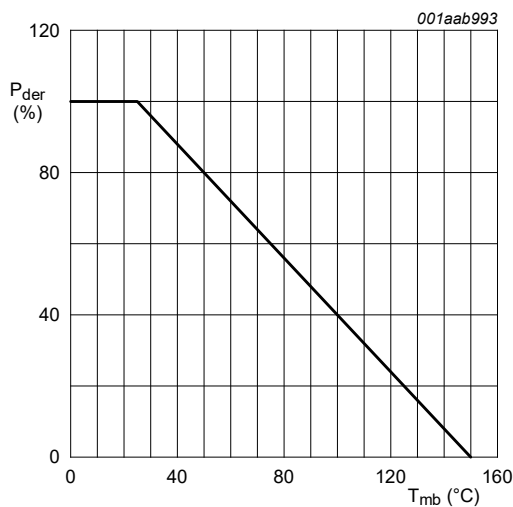
| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------|--------------------------------|---|-----|------|--------------------|
| V_{CESM} | collector-emitter peak voltage | $V_{BE} = 0\text{ V}$ | - | 1000 | V |
| V_{CEO} | collector-emitter voltage | $I_B = 0\text{ A}$ | - | 500 | V |
| I_C | collector current | Fig. 1; Fig. 2; Fig. 3 | - | 5 | A |
| I_{CM} | peak collector current | | - | 10 | A |
| I_B | base current | | - | 2 | A |
| I_{BM} | peak base current | | - | 4 | A |
| P_{tot} | total power dissipation | $T_{mb} \leq 25\text{ }^{\circ}\text{C}$; Fig. 4 | - | 100 | W |
| T_{stg} | storage temperature | | -65 | 150 | $^{\circ}\text{C}$ |
| T_j | junction temperature | | - | 150 | $^{\circ}\text{C}$ |





- (1) P_{tot} maximum and P_{tot} peak maximum lines.
- (2) Second breakdown limits.
- (3) I = Region of permissible DC operation.
II = Extension for repetitive pulse operation.
III = Extension during turn-on in single transistor converters provided that $R_{BE} \leq 100 \Omega$ and $t_p \leq 0.6 \mu s$.

Fig. 3. Forward bias safe operating area for $T_{mb} \leq 25^\circ C$



$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ C)}} \times 100\%$$

Fig. 4. Normalized total power dissipation as a function of mounting base temperature

8. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|----------------|--|------------------------|--|-----|-----|------|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | Fig. 5 | | - | - | 1.25 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient free air | in free air | | - | 60 | - | K/W |

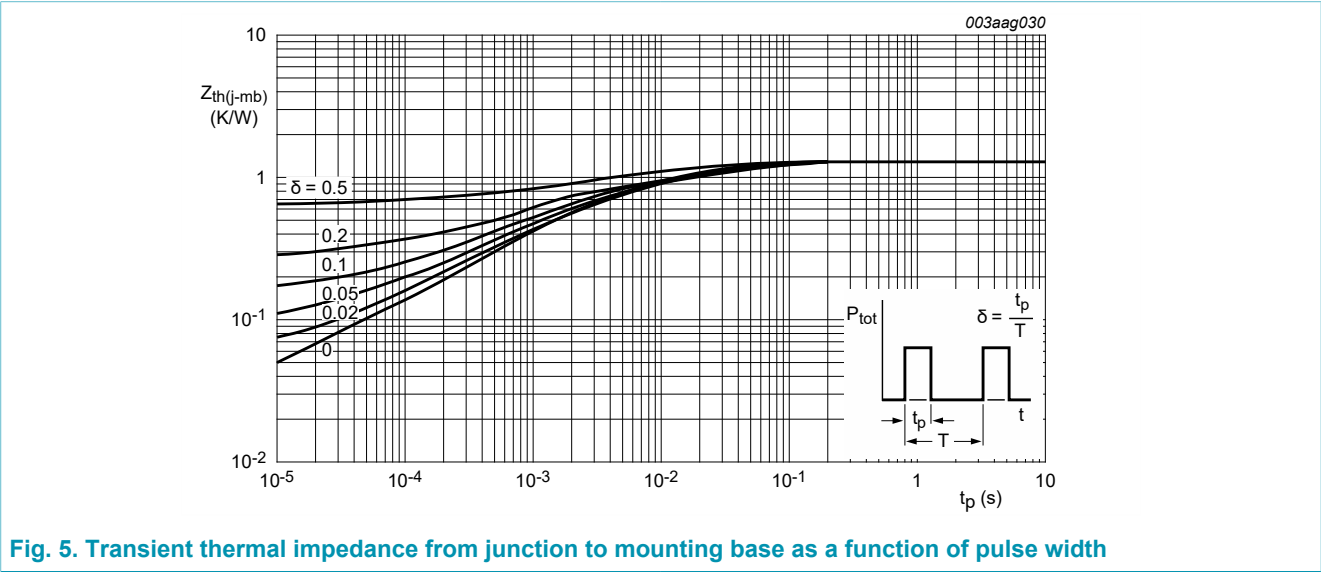


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse width

9. Characteristics

Table 6. Characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|--|--|---|--|-----|------|------|------|
| Static characteristics | | | | | | | |
| I _{CES} | collector-emitter cut-off current (base shorted) | V _{BE} = 0 V; V _{CE} = 1000 V; T _{mb} = 25 °C; Measured with half-sine wave voltage (curve tracer) | | - | - | 1 | mA |
| | | V _{BE} = 0 V; V _{CE} = 1000 V; T _{mb} = 125 °C; Measured with half-sine wave voltage (curve tracer) | | - | - | 2 | mA |
| I _{CBO} | collector-base cut-off current (emitter open) | V _{CB} = 1000 V; I _E = 0 A; T _{mb} = 25 °C; Measured with half-sine wave voltage (curve tracer) | | - | - | 1 | mA |
| I _{CEO} | collector-emitter cut-off current (base open) | V _{CE} = 500 V; I _B = 0 A; T _{mb} = 25 °C; Measured with half-sine wave voltage (curve tracer) | | - | - | 0.1 | mA |
| I _{EBO} | emitter-base cut-off current (collector open) | V _{EB} = 9 V; I _C = 0 A; T _{mb} = 25 °C | | - | - | 0.1 | mA |
| V _{CEOsus} | collector-emitter sustaining voltage (base open) | I _B = 0 A; I _C = 100 mA; L _C = 25 mH; T _{mb} = 25 °C; Fig. 6 ; Fig. 7 | | 500 | - | - | V |
| V _{CEsat} | collector-emitter saturation voltage | I _C = 3 A; I _B = 0.6 A; T _{mb} = 25 °C; Fig. 8 ; Fig. 9 | | - | 0.35 | 1.5 | V |
| V _{BEsat} | base-emitter saturation voltage | I _C = 3 A; I _B = 0.6 A; T _{mb} = 25 °C; Fig. 10 | | - | 1.01 | 1.3 | V |
| h _{FE} | DC current gain | I _C = 5 mA; V _{CE} = 5 V; T _{mb} = 25 °C; Fig. 11 | | 10 | 22 | 35 | |
| | | I _C = 500 mA; V _{CE} = 5 V; T _{mb} = 25 °C; Fig. 11 | | 14 | 25 | 35 | |
| h _{FEsat} | DC saturation current gain | I _C = 2.5 A; V _{CE} = 5 V; T _{mb} = 25 °C; Fig. 11 | | 10 | 13.5 | 17 | |
| | | I _C = 3 A; V _{CE} = 5 V; T _{mb} = 25 °C; Fig. 11 | | - | 11 | - | |
| Dynamic characteristics (switching times - resistive load) | | | | | | | |
| t _s | storage time | I _C = 2.5 A; I _{Bon} = 0.5 A; I _{Boff} = -0.5 A; R _L = 75 Ω; T _{mb} = 25 °C; Fig. 12 ; Fig. 13 | | - | 3.3 | 4 | μs |
| t _f | fall time | | | - | 0.33 | 0.45 | μs |
| Dynamic characteristics (switching times - inductive load) | | | | | | | |
| t _s | storage time | I _C = 2.5 A; I _{Bon} = 0.5 A; V _{BB} = -5 V; L _B = 1 μH; T _{mb} = 25 °C; Fig. 14 ; Fig. 15 | | - | 1.4 | 1.6 | μs |
| | | I _C = 2.5 A; I _{Bon} = 0.5 A; V _{BB} = -5 V; L _B = 1 μH; T _j = 100 °C; Fig. 14 ; Fig. 15 | | - | 1.7 | 1.9 | μs |
| t _f | fall time | I _C = 2.5 A; I _{Bon} = 0.5 A; V _{BB} = -5 V; L _B = 1 μH; T _{mb} = 25 °C; Fig. 14 ; Fig. 15 | | - | 145 | 160 | ns |
| | | I _C = 2.5 A; I _{Bon} = 0.5 A; V _{BB} = -5 V; L _B = 1 μH; T _j = 100 °C; Fig. 14 ; Fig. 15 | | - | 160 | 200 | ns |

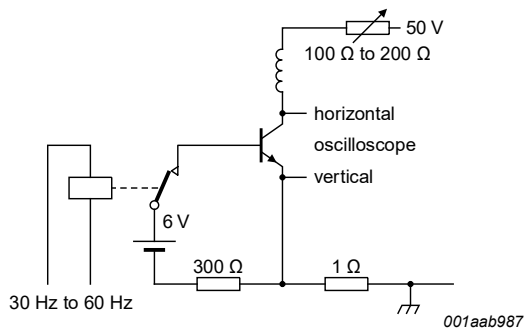


Fig. 6. Test circuit for collector-emitter sustaining voltage

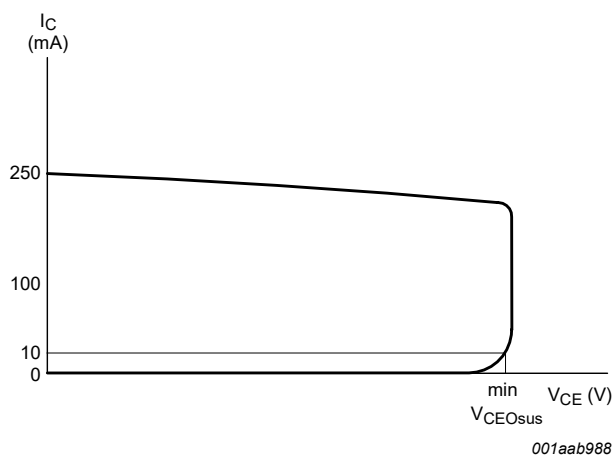


Fig. 7. Oscilloscope display for collector-emitter sustaining voltage test waveform

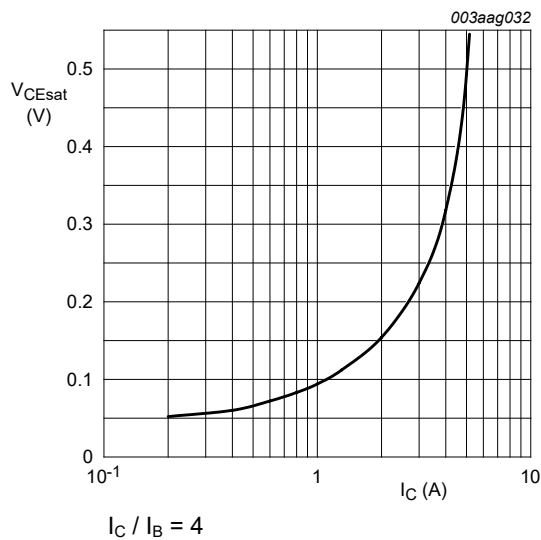


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

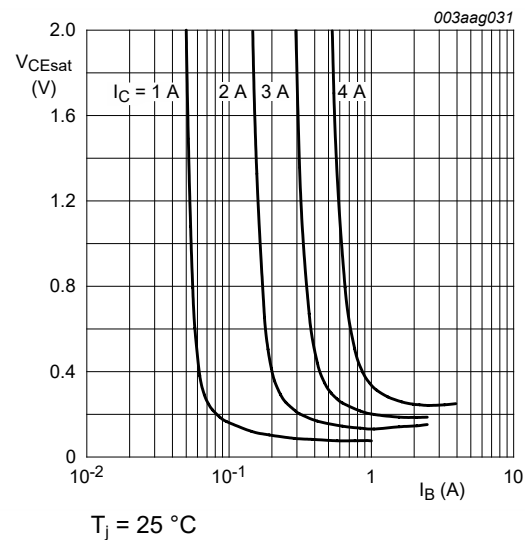


Fig. 9. Collector-emitter saturation voltage as a function of base current; typical values

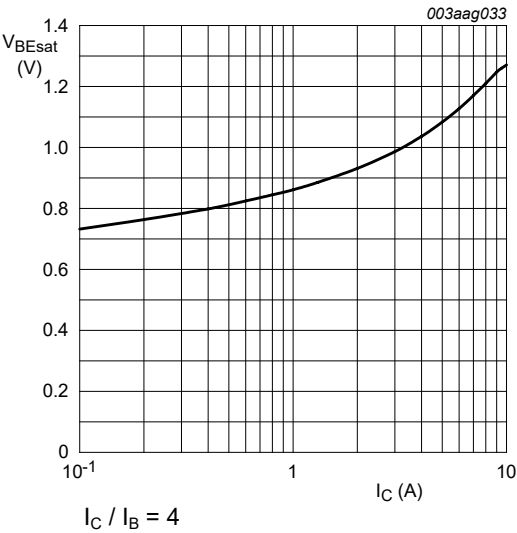


Fig. 10. Base-emitter saturation voltage as a function of collector current; typical values

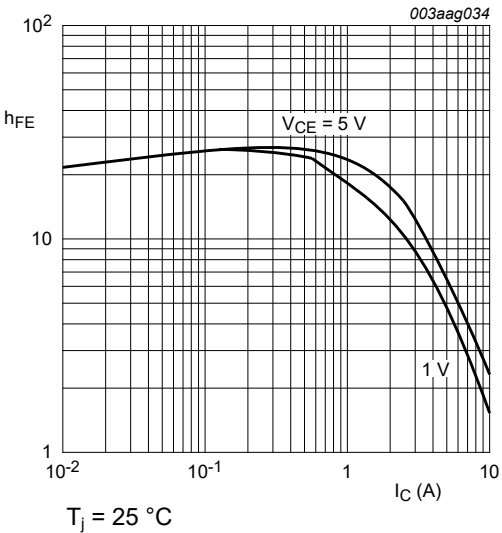
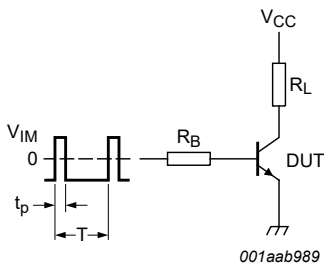


Fig. 11. DC current gain as a function of collector current; typical values



$V_{IM} = -6$ V to $+8$ V; $V_{CC} = 250$ V; $t_p = 20$ μ s;
 $\delta = t_p / T = 0.01$
 R_B and R_L calculated from I_{Con} and I_{Bon} requirements

Fig. 12. Test circuit for resistive load switching

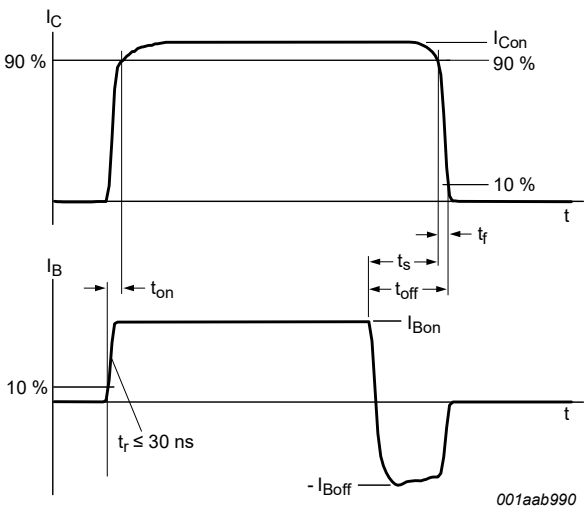
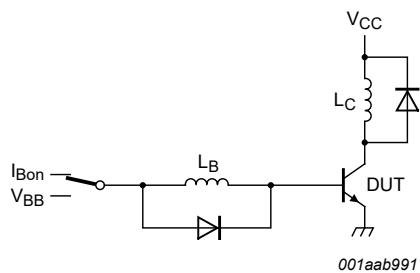


Fig. 13. Switching times waveforms for resistive load



$V_{CC} = 300\text{ V}$; $V_{BB} = -5\text{ V}$; $L_C = 200\text{ }\mu\text{H}$; $L_B = 1\text{ }\mu\text{H}$.

Fig. 14. Test circuit for inductive load switching

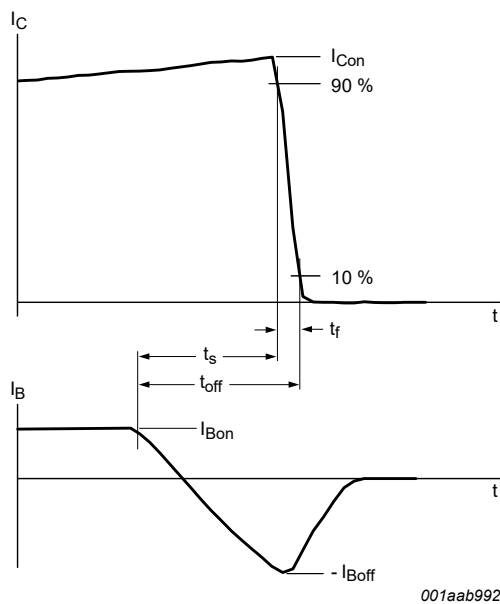


Fig. 15. Switching times waveforms for inductive load

10. Package outline

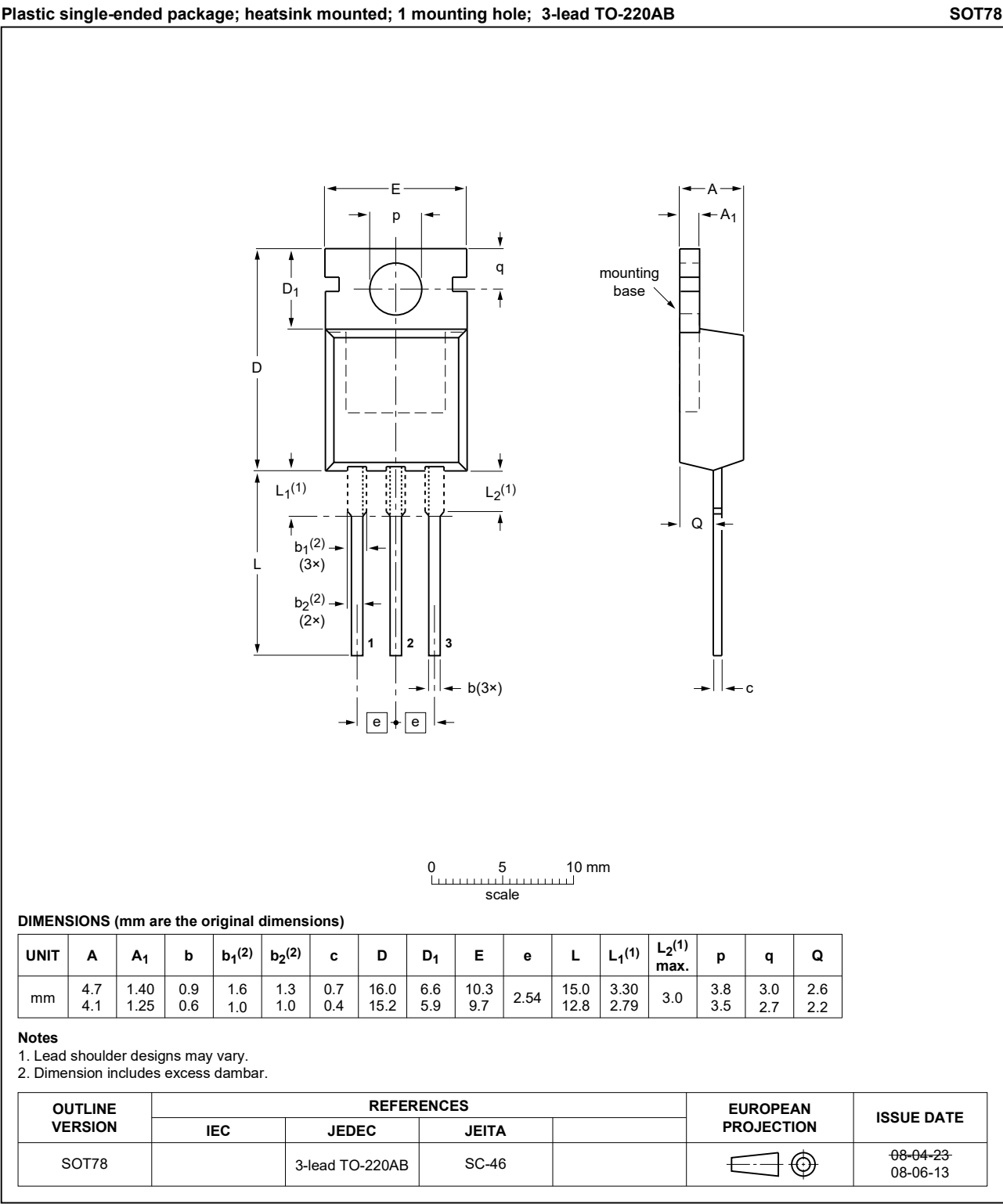


Fig. 16. Package outline TO-220AB (SOT78)

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|--------------------------------|--------------------|---|
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